

THE SIDEPLATE® LICENSE FEE PROVIDES FOR THE FOLLOWING

- A non-exclusive license to use SidePlate® connection technology on the project
- Prequalification of the SidePlate® steel frame connection system in accordance with latest edition of AISC 341 – Refer to ICCES ESR-1275, COLA 25393 or OSHPD’s acceptance for plan review of the SidePlate steel frame connection technology design guidelines
- Technical assistance rendered to the structural engineer of record (SEOR) in the modeling, analysis and final optimization of the lateral steel frame structure, including final optimization of beam and column sizes required to satisfy the project’s design criteria using the increased stiffness properties of the SidePlate® connection system
 - o NOTE: SidePlate® connection stiffness significantly reduces the required weight of steel frame beams and columns comprising the lateral steel frame structure
- Design of all project-specific SidePlate® connections, as identified on the structural drawings, Design includes stamped and signed SidePlate® connection notes and details drawn with AutoCAD®, and SidePlate® connection calculations
- Plan check support to obtain project permit from the jurisdictional agency, as it relates to the SidePlate® connection system
- Electronic format of the SidePlate® Notice of Intellectual Property and SidePlate® patent labels
- Review and disposition of:
 - o Quality control procedures, welding procedure specifications (WPS’s) and supporting procedure qualification records (PQR’s) to be used for the fabrication and erection of steel frames using SidePlate® connection technology
 - o Steel shop drawings that incorporate SidePlate® connections
- Consultation services as required to resolve a given request for information (RFI) for the project related to SidePlate® connection technology
 - o Conduct a maximum of three periodic observations to review fabrication and/or erection of steel frame connections using SidePlate® connection technology, for the limited purpose of determining conformance with SidePlate® connection technology used on the project